SPECIFICATIONS FOR NICHIA BLUE LED

MODEL: **NSPB300A**

NICHIA CORPORATION
1. SPECIFICATIONS

(1) Absolute Maximum Ratings (Ta=25°C)

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Absolute Maximum Rating</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Forward Current</td>
<td>If</td>
<td>30</td>
<td>mA</td>
</tr>
<tr>
<td>Pulse Forward Current</td>
<td>Ifp</td>
<td>100</td>
<td>mA</td>
</tr>
<tr>
<td>Reverse Voltage</td>
<td>Vr</td>
<td>5</td>
<td>V</td>
</tr>
<tr>
<td>Power Dissipation</td>
<td>Pd</td>
<td>120</td>
<td>mW</td>
</tr>
<tr>
<td>Operating Temperature</td>
<td>Topr</td>
<td>-30 ~ +85</td>
<td>°C</td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>Tstg</td>
<td>-40 ~ +100</td>
<td>°C</td>
</tr>
<tr>
<td>Soldering Temperature</td>
<td>Tsld</td>
<td>265°C for 10sec.</td>
<td></td>
</tr>
</tbody>
</table>

Ifp Conditions: Pulse Width ≤ 10msec. and Duty ≤ 1/10

(2) Initial Electrical/Optical Characteristics (Ta=25°C)

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Forward Voltage</td>
<td>Vf</td>
<td>If=20[mA]</td>
<td>-</td>
<td>3.6</td>
<td>4.0</td>
<td>V</td>
</tr>
<tr>
<td>Reverse Current</td>
<td>Ir</td>
<td>Vr=5[V]</td>
<td>-</td>
<td>-</td>
<td>50</td>
<td>µA</td>
</tr>
<tr>
<td>Luminous Intensity</td>
<td>Iv</td>
<td>If=20[mA]</td>
<td>2760</td>
<td>3200</td>
<td>3880</td>
<td>mcd</td>
</tr>
<tr>
<td></td>
<td>Rank T</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Rank S</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Rank R</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

* Measurement Uncertainty of the Luminous Intensity: ± 10%

Color Rank (If=20mA, Ta=25°C)

<table>
<thead>
<tr>
<th>x</th>
<th>0.11</th>
<th>0.11</th>
<th>0.15</th>
<th>0.15</th>
</tr>
</thead>
<tbody>
<tr>
<td>y</td>
<td>0.04</td>
<td>0.10</td>
<td>0.10</td>
<td>0.04</td>
</tr>
</tbody>
</table>

* Measurement Uncertainty of the Color Coordinates: ± 0.01

* One delivery will include up to one color rank and three luminous intensity ranks of the products.

The quantity-ratio of the ranks is decided by Nichia.

2. TYPICAL INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS

Please refer to figure’s page.

3. OUTLINE DIMENSIONS AND MATERIALS

Please refer to figure’s page.

Material as follows:
- Resin(Mold): Epoxy Resin
- Leadframe: Ag plating Copper Alloy
4. PACKAGING
· The LEDs are packed in cardboard boxes after packaging in anti-electrostatic bags. According to the total delivery amount, cardboard boxes will be used to protect the LEDs from mechanical shocks during transportation. Please refer to figure’s page. The label on the minimum packing unit bag shows; Part Number, Lot Number, Ranking, Quantity
· The boxes are not water resistant and therefore must be kept away from water and moisture.

5. LOT NUMBER
The first six digits number shows lot number.
The lot number is composed of the following characters;

〇 □ × × × × - △ ■

〇 - Year (1 for 2001, 2 for 2002)
□ - Month (1 for Jan., 9 for Sep., A for Oct., B for Nov.)
× × × × - Nichia's Product Number
△ - Ranking by Color Coordinates
■ - Ranking by Luminous Intensity
6. RELIABILITY

(1) TEST ITEMS AND RESULTS

<table>
<thead>
<tr>
<th>Test Item</th>
<th>Standard Test Method</th>
<th>Test Conditions</th>
<th>Note</th>
<th>Number of Damaged</th>
</tr>
</thead>
<tbody>
<tr>
<td>Resistance to Soldering Heat</td>
<td>JEITA ED-4701 300 302</td>
<td>Tsld=260 ± 5°C, 10sec. 3mm from the base of the epoxy bulb</td>
<td>1 time</td>
<td>0/100</td>
</tr>
<tr>
<td>Solderability</td>
<td>JEITA ED-4701 300 303</td>
<td>Tsld=235 ± 5°C, 5sec. (using flux)</td>
<td>1 time over 95%</td>
<td>0/100</td>
</tr>
<tr>
<td>Thermal Shock</td>
<td>JEITA ED-4701 100 105</td>
<td>0°C ~ 100°C 15sec. 15sec.</td>
<td>100 cycles</td>
<td>0/100</td>
</tr>
<tr>
<td>Temperature Cycle</td>
<td>JEITA ED-4701 200 203</td>
<td>-40°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min.</td>
<td>100 cycles</td>
<td>0/100</td>
</tr>
<tr>
<td>Moisture Resistance Cyclic</td>
<td>JEITA ED-4701 400 401</td>
<td>25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle</td>
<td>10 cycles</td>
<td>0/100</td>
</tr>
<tr>
<td>Terminal Strength (bending test)</td>
<td>JEITA ED-4701 400 401</td>
<td>Load 5N (0.5kgf) 0° ~ 90° ~ 0° bend 2 times</td>
<td>No noticeable damage</td>
<td>0/100</td>
</tr>
<tr>
<td>Terminal Strength (pull test)</td>
<td>JEITA ED-4701 400 401</td>
<td>Load 10N (1kgf) 10 ± 1 sec.</td>
<td>No noticeable damage</td>
<td>0/100</td>
</tr>
<tr>
<td>High Temperature Storage</td>
<td>JEITA ED-4701 200 201</td>
<td>Ta=100°C</td>
<td>1000hrs.</td>
<td>0/100</td>
</tr>
<tr>
<td>Temperature Humidity Storage</td>
<td>JEITA ED-4701 100 103</td>
<td>Ta=60°C, RH=90%</td>
<td>1000hrs.</td>
<td>0/100</td>
</tr>
<tr>
<td>Low Temperature Storage</td>
<td>JEITA ED-4701 200 202</td>
<td>Ta=-40°C</td>
<td>1000hrs.</td>
<td>0/100</td>
</tr>
<tr>
<td>Steady State Operating Life</td>
<td></td>
<td>Ta=25°C, If=30mA</td>
<td>1000hrs.</td>
<td>0/100</td>
</tr>
<tr>
<td>Steady State Operating Life of High Humidity Heat</td>
<td></td>
<td>60°C, RH=90%, If=20mA</td>
<td>500hrs.</td>
<td>0/100</td>
</tr>
<tr>
<td>Steady State Operating Life of Low Temperature</td>
<td></td>
<td>Ta=-30°C, If=20mA</td>
<td>1000hrs.</td>
<td>0/100</td>
</tr>
</tbody>
</table>

(2) CRITERIA FOR JUDGING THE DAMAGE

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Test Conditions</th>
<th>Criteria for Judgement</th>
</tr>
</thead>
<tbody>
<tr>
<td>Forward Voltage</td>
<td>V_F</td>
<td>If=20mA</td>
<td>Min.</td>
</tr>
<tr>
<td>Reverse Current</td>
<td>I_R</td>
<td>V_R=5V</td>
<td>Max. U.S.L.* × 1.1</td>
</tr>
<tr>
<td>Luminous Intensity</td>
<td>I_V</td>
<td>If=20mA</td>
<td>L.S.L.** × 0.7</td>
</tr>
</tbody>
</table>

7. CAUTIONS

(1) Lead Forming
- When forming leads, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
  Do not use the base of the leadframe as a fulcrum during lead forming.
- Lead forming should be done before soldering.
- Do not apply any bending stress to the base of the lead. The stress to the base may damage the characteristics or it may break the LEDs.
- When mounting the LEDs onto a printed circuit board, the holes on the circuit board should be exactly aligned with the leads of the LEDs. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

(2) Storage
- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Nichia and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Nichia LED leadframes are comprised of a silver plated copper alloy. The silver surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

(3) Static Electricity
- Static electricity or surge voltage damages the LEDs.
  It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
- When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is recommended).
- Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.
  Criteria: \[(V_F > 2.0V \text{ at } I_F=0.5mA)\]
(4) Soldering Conditions

- Nichia LED leadframes are comprised of a silver plated copper alloy. This substance has a low thermal coefficient (easily conducts heat). Careful attention should be paid during soldering.
- Solder the LED no closer than 3mm from the base of the epoxy bulb. Soldering beyond the base of the tie bar is recommended.
- Recommended soldering conditions

<table>
<thead>
<tr>
<th></th>
<th>Dip Soldering</th>
<th>Soldering</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pre-Heat</td>
<td>100°C Max.</td>
<td>300°C Max.</td>
</tr>
<tr>
<td>Pre-Heat Time</td>
<td>60 seconds Max.</td>
<td>3 seconds Max.</td>
</tr>
<tr>
<td>Solder Bath</td>
<td>260°C Max.</td>
<td>No closer than 3 mm from</td>
</tr>
<tr>
<td>Temperature</td>
<td></td>
<td>the base of the epoxy</td>
</tr>
<tr>
<td>Dipping Time</td>
<td>10 seconds Max.</td>
<td>bulb.</td>
</tr>
<tr>
<td>Dipping Position</td>
<td>No lower than 3 mm from the</td>
<td></td>
</tr>
<tr>
<td></td>
<td>base of the epoxy bulb.</td>
<td></td>
</tr>
</tbody>
</table>

- Do not apply any stress to the lead particularly when heated.
- The LEDs must not be repositioned after soldering.
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- Direct soldering onto a PC board should be avoided. Mechanical stress to the resin may be caused from warping of the PC board or from the clinching and cutting of the leadframes. When it is absolutely necessary, the LEDs may be mounted in this fashion but the User will assume responsibility for any problems. Direct soldering should only be done after testing has confirmed that no damage, such as wire bond failure or resin deterioration, will occur. Nichia’s LEDs should not be soldered directly to double sided PC boards because the heat will deteriorate the epoxy resin.
- When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.
- Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.

(5) Heat Generation

- Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.

(6) Cleaning

- It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.
(7) Safety Guideline for Human Eyes
· In 1993, the International Electric Committee (IEC) issued a standard concerning laser product safety (IEC 825-1). Since then, this standard has been applied for diffused light sources (LEDs) as well as lasers. In 1998 IEC 60825-1 Edition 1.1 evaluated the magnitude of the light source. In 2001 IEC 60825-1 Amendment 2 converted the laser class into 7 classes for end products. Components are excluded from this system. Products which contain visible LEDs are now classified as class 1. Products containing UV LEDs are class 1M. Products containing LEDs can be classified as class 2 in cases where viewing angles are narrow, optical manipulation intensifies the light, and/or the energy emitted is high. For these systems it is recommended to avoid long term exposure. It is also recommended to follow the IEC regulations regarding safety and labeling of products.

(8) Others
· Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
· The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult Nichia’s sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
· User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the User shall inform Nichia directly before disassembling or analysis.
· The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
· The appearance and specifications of the product may be modified for improvement without notice.
ICI Chromaticity Diagram
- **Forward Current vs. Chromaticity Coordinate (λ, D)**

- **Spectrum**

- **Forward Current vs. Dominant Wavelength**

- **Ambient Temperature vs. Dominant Wavelength**

- **Directivity (NSPB300A)**

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**Model**: NSPB300A

**Title**: TYP.CHARACTERISTICS

**No.**: 011130109701
ITEM MATERIALS
RESIN(MOLD) Epoxy Resin
LEAD FRAME Ag Plating Copper Alloy

Remark:
Bare copper alloy is exposed at tie-bar portion after cutting.
The lamps have sharp and hard points that may injure human eyes or fingers etc., so please pay enough care in the handling.

NICHIA CORPORATION

Model NSPB300A
Unit mm
3/1 Scale
Allow ±0.2

No. 010831105691
The quantity is printed on this bag.

* One box contains 8 bags at maximum.

NICHIA CORPORATION
Title PACKING
No. 020723201101
Anti-electrostatic bag

Cardboard box B

360

135

215

4t

The quantity is printed on this bag.

Cardboard box A

Cardboard

Print

NICHIA

XXXX LED

TYPE  NxPxxxxxx

LOT   xxxxxx- △ ■

QTY   pcs

NICHIA CORPORATION
491 OKA KAMINAKA ANAN TOSHIHAMA JAPAN

CAUTION TO ELECTROSTATIC DAMAGE
静電気に注意

Label

NICHIA

XXXX LED

TYPE  NxPxxxxxx

QTY  PCS

NICHIA CORPORATION
491 OKA KAMINAKA, ANAN-TOKUSHIMA, JAPAN

* Put this label on the cardboard box B.

Cardboard box B
360×135×215×4t

* The cardboard box B contains 2 cardboard box A at maximum.

NICHIA CORPORATION

Model  NxPxxxxxx

Title  PACKING

No.  020723201111
The quantity is printed on this bag.

* One box contains 20 bags at maximum.

* Put this label on the cardboard box.
The cardboard box B contains 4 cardboard box A at maximum.

The quantity is printed on this bag.

* The cardboard box B contains 4 cardboard box A at maximum.

Put this label on the cardboard box B.